



Attorney's Docket No.: 042390.P10305

PATENT

#S/A  
via  
7/25/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of )

Murali, Venkatesan )

Application No.: 09/741,532 )

Filing Date: December 19, 2000 )

For: METHOD OF CREATING A )  
PHOTONIC VIA USING )  
DEPOSITION )

Examiner: Chen, Kin Chan

Art Unit: 1765

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JUL 24 2002

TC 1700

Assistant Commissioner for Patents  
Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Office Action mailed March 15, 2002, Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks:

IN THE CLAIMS:

Please cancel claims 5-15, without prejudice.

Please amend the claims as follows:

- 1 1. (Amended) A method of making a photonic via comprising:
- 2 making a hole in a substrate, wherein the hole extends from one side of the
- 3 substrate to an opposite side of the substrate;

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